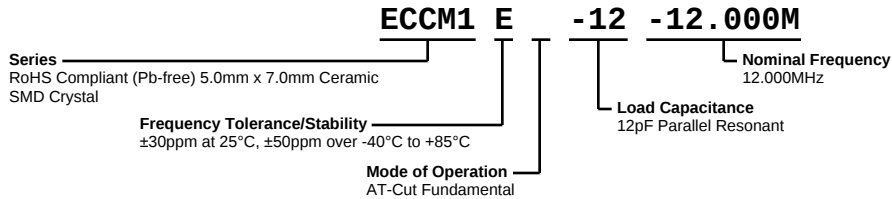


# ECCM1E-12-12.000M



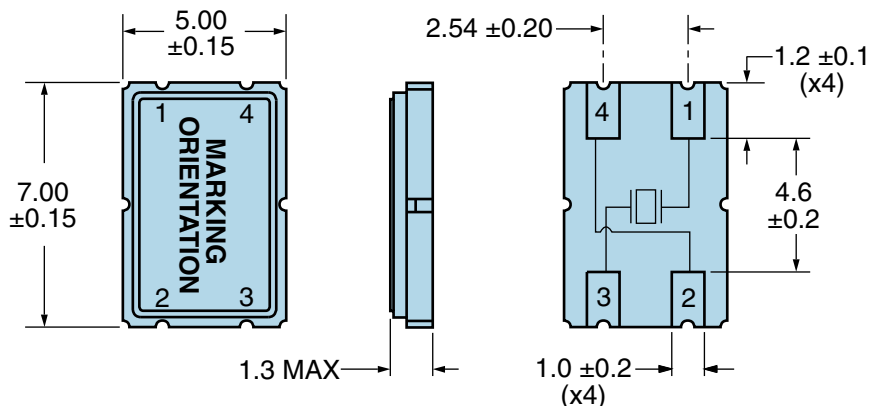
## ELECTRICAL SPECIFICATIONS

|                               |                                                                    |
|-------------------------------|--------------------------------------------------------------------|
| Nominal Frequency             | 12.000MHz                                                          |
| Frequency Tolerance/Stability | $\pm 30\text{ppm}$ at 25°C, $\pm 50\text{ppm}$ over -40°C to +85°C |
| Aging at 25°C                 | $\pm 3\text{ppm/year}$ Maximum                                     |
| Load Capacitance              | 12pF Parallel Resonant                                             |
| Shunt Capacitance (C0)        | 7pF Maximum                                                        |
| Equivalent Series Resistance  | 50 Ohms Maximum                                                    |
| Mode of Operation             | AT-Cut Fundamental                                                 |
| Drive Level                   | 50μWatts Maximum, 50μWatts Correlation                             |
| Spurious Response             | -3dB Minimum (Measured from Fo to Fo +5000ppm)                     |
| Storage Temperature Range     | -40°C to +85°C                                                     |
| Insulation Resistance         | 500 Megaohms Minimum (Measured at 100Vdc)                          |

## ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

|                              |                                               |
|------------------------------|-----------------------------------------------|
| ESD Susceptibility           | MIL-STD-883, Method 3015, Class 1, HBM: 1500V |
| Fine Leak Test               | MIL-STD-883, Method 1014, Condition A         |
| Flammability                 | UL94-V0                                       |
| Gross Leak Test              | MIL-STD-883, Method 1014, Condition C         |
| Mechanical Shock             | MIL-STD-883, Method 2002, Condition B         |
| Moisture Resistance          | MIL-STD-883, Method 1004                      |
| Moisture Sensitivity         | J-STD-020, MSL 1                              |
| Resistance to Soldering Heat | MIL-STD-202, Method 210, Condition K          |
| Resistance to Solvents       | MIL-STD-202, Method 215                       |
| Solderability                | MIL-STD-883, Method 2003                      |
| Temperature Cycling          | MIL-STD-883, Method 1010, Condition B         |
| Vibration                    | MIL-STD-883, Method 2007, Condition A         |

## MECHANICAL DIMENSIONS (all dimensions in millimeters)



Note: Chamfer and index mark not shown.

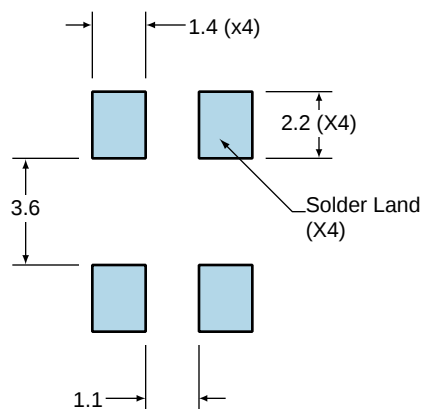
| PIN | CONNECTION   |
|-----|--------------|
| 1   | Crystal      |
| 2   | Cover/Ground |
| 3   | Crystal      |
| 4   | Cover/Ground |

| LINE | MARKING                                                   |
|------|-----------------------------------------------------------|
| 1    | <b>E12.00</b><br>E=Ecliptek Designator                    |
| 2    | <b>XXXXXX</b><br>XXXXXX=Ecliptek Manufacturing Identifier |

# ECCM1E-12-12.000M

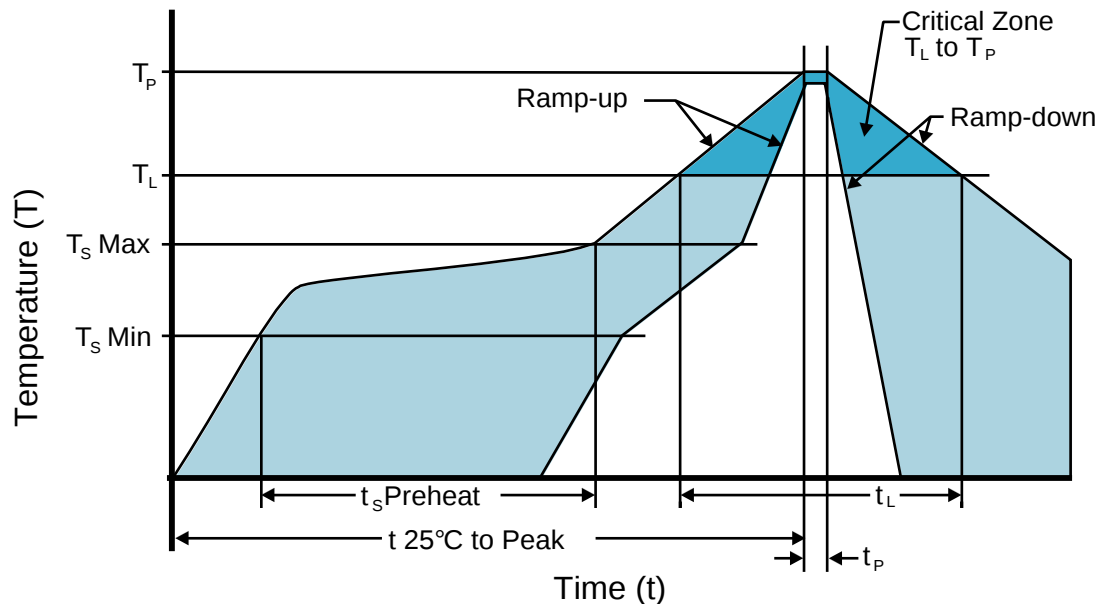
## Suggested Solder Pad Layout

All Dimensions in Millimeters



All Tolerances are  $\pm 0.1$

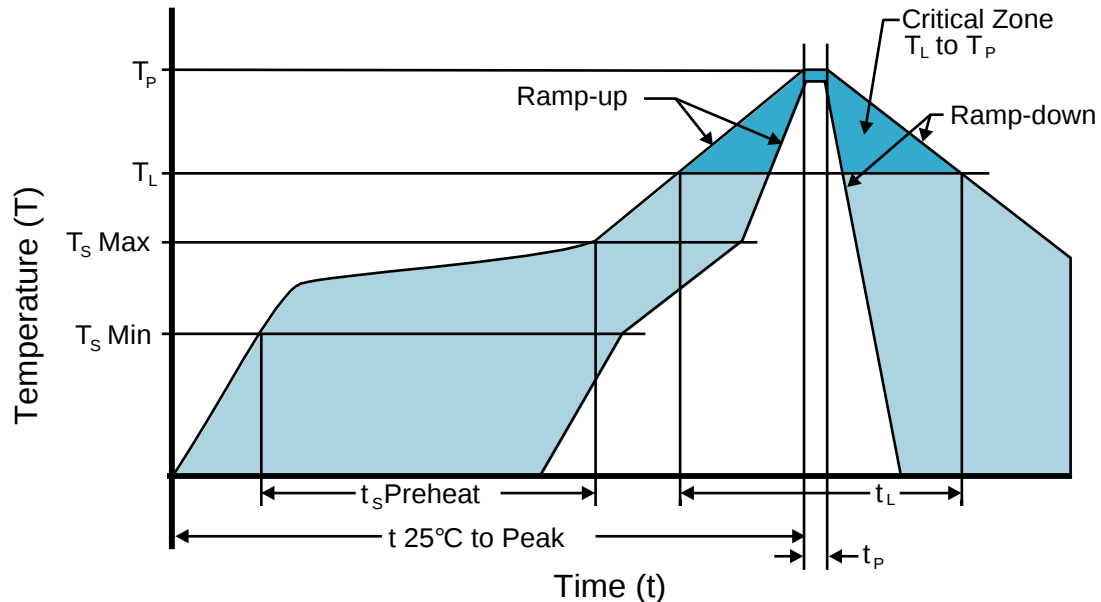
## Recommended Solder Reflow Methods



### High Temperature Infrared/Convection

|                                                          |                                      |
|----------------------------------------------------------|--------------------------------------|
| <b>T<sub>s</sub> MAX to T<sub>L</sub> (Ramp-up Rate)</b> | 3°C/second Maximum                   |
| <b>Preheat</b>                                           |                                      |
| - Temperature Minimum (T <sub>s</sub> MIN)               | 150°C                                |
| - Temperature Typical (T <sub>s</sub> TYP)               | 175°C                                |
| - Temperature Maximum (T <sub>s</sub> MAX)               | 200°C                                |
| - Time (t <sub>s</sub> MIN)                              | 60 - 180 Seconds                     |
| <b>Ramp-up Rate (T<sub>L</sub> to T<sub>P</sub>)</b>     | 3°C/second Maximum                   |
| <b>Time Maintained Above:</b>                            |                                      |
| - Temperature (T <sub>L</sub> )                          | 217°C                                |
| - Time (t <sub>L</sub> )                                 | 60 - 150 Seconds                     |
| <b>Peak Temperature (T<sub>P</sub>)</b>                  | 260°C Maximum for 10 Seconds Maximum |
| <b>Target Peak Temperature (T<sub>P</sub> Target)</b>    | 250°C +0/-5°C                        |
| <b>Time within 5°C of actual peak (t<sub>p</sub>)</b>    | 20 - 40 seconds                      |
| <b>Ramp-down Rate</b>                                    | 6°C/second Maximum                   |
| <b>Time 25°C to Peak Temperature (t)</b>                 | 8 minutes Maximum                    |
| <b>Moisture Sensitivity Level</b>                        | Level 1                              |

## Recommended Solder Reflow Methods



### Low Temperature Infrared/Convection 240°C

$T_s$  MAX to  $T_L$  (Ramp-up Rate) 5°C/second Maximum

#### Preheat

- Temperature Minimum ( $T_s$  MIN) N/A  
 - Temperature Typical ( $T_s$  TYP) 150°C  
 - Temperature Maximum ( $T_s$  MAX) N/A  
 - Time ( $t_s$  MIN) 60 - 120 Seconds

Ramp-up Rate ( $T_L$  to  $T_p$ ) 5°C/second Maximum

#### Time Maintained Above:

- Temperature ( $T_L$ ) 150°C  
 - Time ( $t_L$ ) 200 Seconds Maximum

Peak Temperature ( $T_p$ ) 240°C Maximum

Target Peak Temperature ( $T_p$  Target) 240°C Maximum 1 Time / 230°C Maximum 2 Times

Time within 5°C of actual peak ( $t_p$ ) 10 seconds Maximum 2 Times / 80 seconds Maximum 1 Time

Ramp-down Rate 5°C/second Maximum

Time 25°C to Peak Temperature (t) N/A

Moisture Sensitivity Level Level 1

### Low Temperature Manual Soldering

185°C Maximum for 10 seconds Maximum, 2 times Maximum.

### High Temperature Manual Soldering

260°C Maximum for 5 seconds Maximum, 2 times Maximum.